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## METHOD FOR PROGRAMMING A THREE-DIMENSIONAL MEMORY ARRAY INCORPORATING SERIAL CHAIN DIODE STACK

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## CROSS-REFERENCE TO RELATED APPLICATIONS

NOW a patent 6,754,102,

[1001] This application is a divisional of Prior Application No. 10/253,074 filed

September 24, 2002, which is a divisional of Application No. 09/897,705 filed June

Now a patent 6 4 20215, 29, 2001, which is a continuation-in-part of U.S. Application No. 09/814,727, filed March 21, 2001, which is a continuation-in-part of U.S. Application No. 09/560,626, now abound oned, filed April 28, 2000; each of which applications is hereby incorporated by reference; and which Application No. 09/897,705, also claims the benefit of the following U.S. provisional applications: U.S. Provisional Application No. 60/277,794 filed on March 21, 2001; U.S. Provisional Application No. 60/277,815 filed on March 21, 2001; and U.S. Provisional Application No. 60/277,738 filed on March 21, 2001; each of which provisional applications is also hereby incorporated by reference.

## **BACKGROUND OF THE INVENTION**

## Field of the Invention

[1002] The present invention relates to low cost, high-density semiconductor memories and, in particular, to one-time-programmable semiconductor memories. More particularly, the invention relates to the field of vertically stacked field programmable non-volatile memory, support circuits useful therewith, and methods of fabrication thereof.